



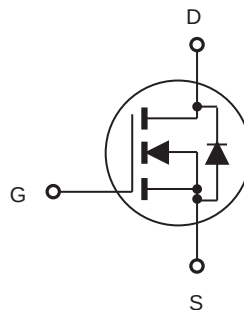
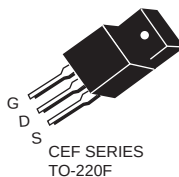
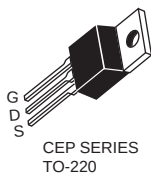
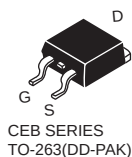
CEP9055/CEB9055 CEF9055

N-Channel Enhancement Mode Field Effect Transistor

FEATURES

Type	V _{DSS}	R _{DS(ON)}	I _D	@V _{GS}
CEP9055	55V	10.5mΩ	100A	10V
CEB9055	55V	10.5mΩ	100A	10V
CEF9055	55V	10.5mΩ	100A ^e	10V

- Super high dense cell design for extremely low R_{DS(ON)}.
- High power and current handling capability.
- Lead free product is acquired.
- TO-220^g & TO-263 package & TO-220F full-pak for through hole.



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	V _{DS}	55		V
Gate-Source Voltage	V _{GS}	±20		V
Drain Current-Continuous	I _D	100	100 ^e	A
Drain Current-Pulsed ^a	I _{DM} ^f	300	300 ^e	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25°C	P _D	200	75	W
		1.3	0.5	W/°C
Single Pulsed Avalanche Energy ^d	E _{AS}	325	325	mJ
Single Pulsed Avalanche Current ^d	I _{AS}	50	50	A
Operating and Store Temperature Range	T _J , T _{stg}	-55 to 175		°C

Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	R _{θJC}	0.75	2	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62.5	65	°C/W



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CEF9055

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

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Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	55			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 55V, V_{GS} = 0V$			10	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{GS} = 20V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{GS} = -20V, V_{DS} = 0V$			-100	nA
On Characteristics ^b						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 250\mu A$	2		4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 62A$		8.8	10.5	m Ω
Forward Transconductance	g_{FS}	$V_{DS} = 25V, I_D = 62A$		28		S
Dynamic Characteristics ^c						
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0\text{ MHz}$		2700		pF
Output Capacitance	C_{oss}			800		pF
Reverse Transfer Capacitance	C_{rss}			115		pF
Switching Characteristics ^c						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 28V, I_D = 62A,$ $V_{GS} = 10V, R_{GEN} = 4.5\Omega$		40	80	ns
Turn-On Rise Time	t_r			20	45	ns
Turn-Off Delay Time	$t_{d(off)}$			65	120	ns
Turn-On Fall Time	t_f			15	35	ns
Total Gate Charge	Q_g	$V_{DS} = 44V, I_D = 62A,$ $V_{GS} = 10V$		60	80	nC
Gate-Source Charge	Q_{gs}			15		nC
Gate-Drain Charge	Q_{gd}			22		nC
Drain-Source Diode Characteristics and Maximun Ratings						
Drain-Source Diode Forward Current	I_S				62	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{GS} = 0V, I_S = 62A$			1.3	V
Notes :						
a.Repetitive Rating : Pulse width limited by maximum junction temperature						
b.Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.						
c.Guaranteed by design, not subject to production testing.						
d.L = 260 μH , $I_{AS} = 50A$, $V_{DD} = 30V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$						
e.Limited only by maximum temperature allowed .						
f .Pulse width limited by safe operating area .						
g.The mounting torque (4-40/M3 screw) in TO-220 package is recommended within 3-4Kgf-cm (MAX. 4Kgf-cm)						



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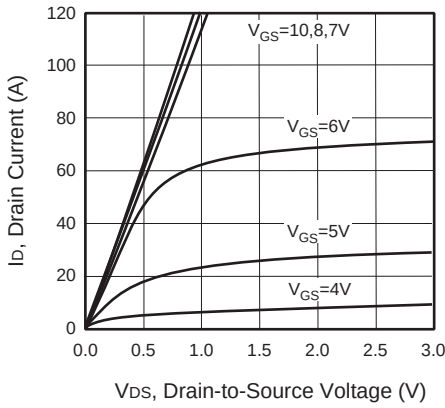


Figure 1. Output Characteristics

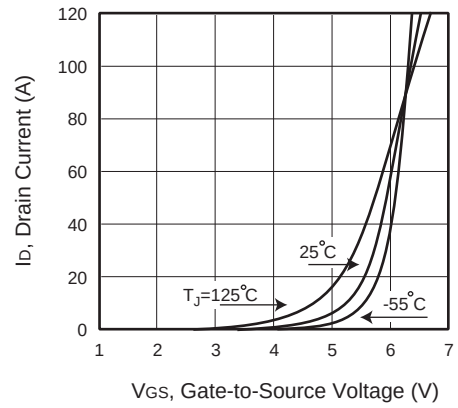


Figure 2. Transfer Characteristics

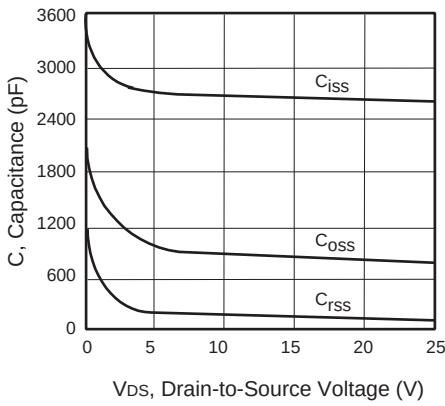


Figure 3. Capacitance

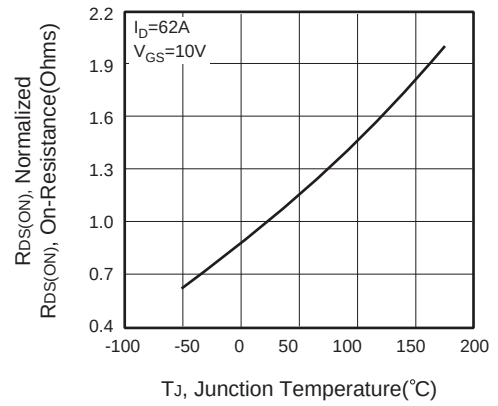


Figure 4. On-Resistance Variation with Temperature

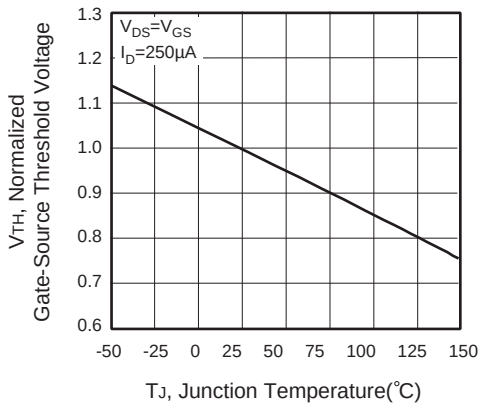


Figure 5. Gate Threshold Variation with Temperature

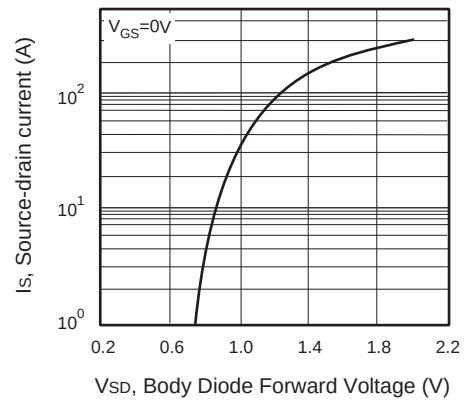


Figure 6. Body Diode Forward Voltage Variation with Source Current



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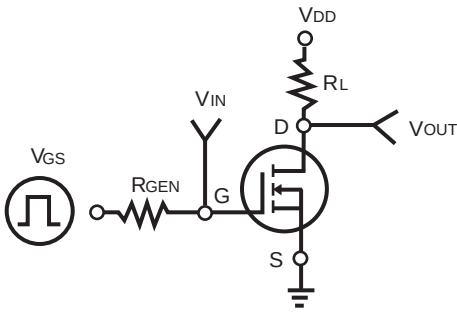
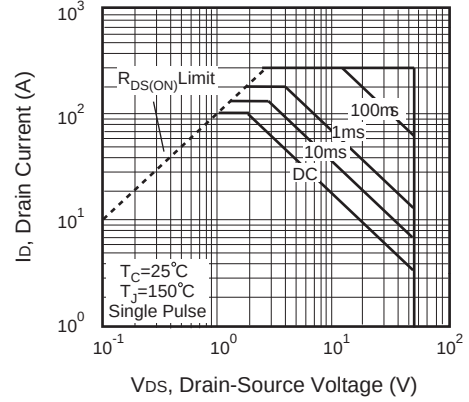
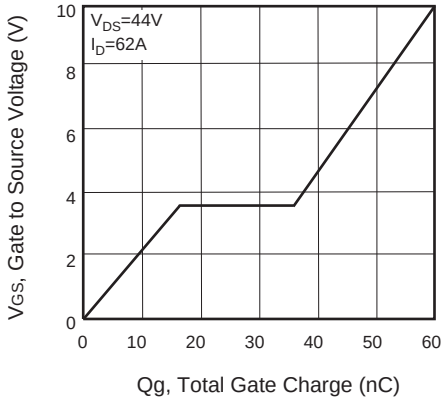


Figure 9. Switching Test Circuit

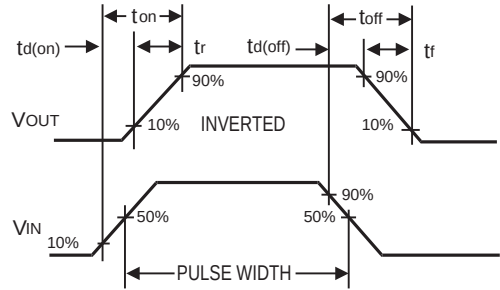


Figure 10. Switching Waveforms

